



# Product Change Notification

**Change Notification #:** 118659-01  
**Change Title:** Select Intel® Ethernet Network Adapter OCP3.0 I350-T4, OEM Gen, PCN 118659-01, Product Design, Label Label and Internal Lock Faceplate Update  
**Reason for Revision:** Material depletion  
**Date of Publication:** February 11, 2022

## Key Characteristics of the Change:

Product Design, Label

## Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material	January 01, 2022
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## Description of Change to the Customer:

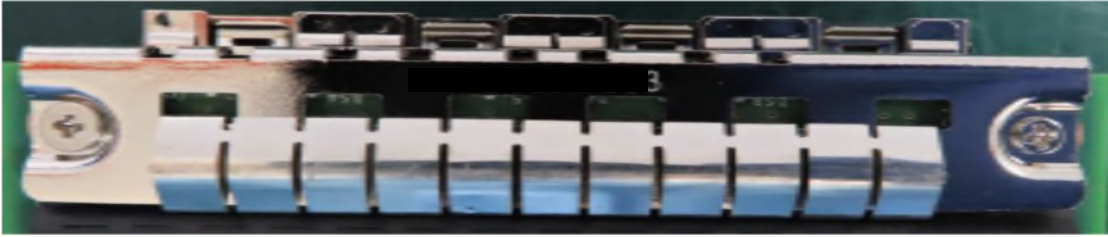
### Reason for Revision: Material depletion

The Intel® Ethernet Network Adapter SKU listed in the product affected table below will undergo the following changes:

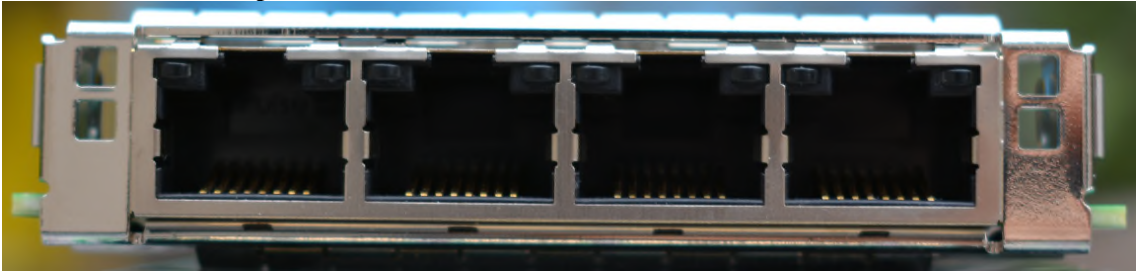
1. ~~The Intel(R) Ethernet Network Adapter OCP3.0 I350 T4 will be updated to use an enhanced OCP3.0 faceplate. The updated faceplate has been enhanced to ensure all mechanical dimensions have tighter tolerances to meet OCP3.0 mechanical Critical to Function requirements. Implementation of the new faceplate will be pushed out to September 2022.~~

### Current Faceplate





New Painter Flat Faceplate







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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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